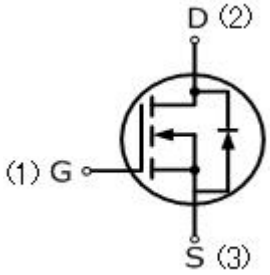
9N90Y

9 Amps,900 Volts N-CHANNEL Power MOSFET

FEATURE

- 9A,900V,$R_{DS(ON)MAX}$=1.4Ω @V_{GS}=10V/4.5A
- Low gate charge
- Low C_{iss}
- Fast switching
- 100% avalanche tested
- Improved dv/dt capabilitv
- Halogen free



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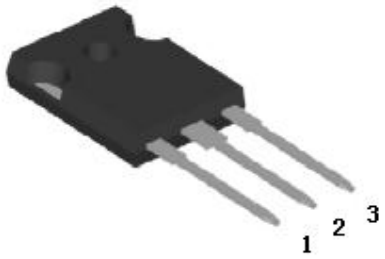


Absolute Maximum Ratings(T_C=25℃,unless otherwise noted)

Parameter	Symbol	9N90Y	UNIT
Drain-Source Voltage	V_{DSS}	900	V
Gate-Source Voltage	V_{GSS}	±30	
Continuous Drain Current	I_D	9	A
Pulsed Drain Current(Note1)	I_{DM}	36	
Single Pulse Avalanche Energy (Note 2)	E_{AS}	1000	mJ
Reverse Diode dV/dt (Note 3)	dv/dt	5	V/ns
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55to+150	℃
Maximum lead temperature for soldering purposes, 1/8″from case for 5 seconds	T_L	260	℃

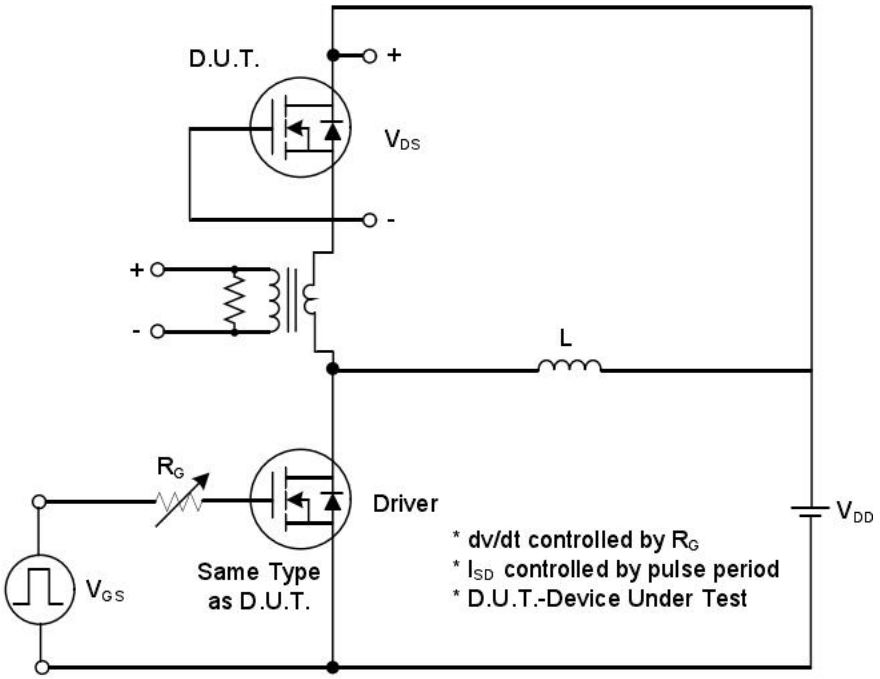
Parameter		Symbol	9N90Y	Units
Thermal resistance , Channel to Case		$R_{th(ch-c)}$	0.83	℃/W
Thermal resistance , Channel to Ambient		$R_{th(ch-a)}$	40	℃/W
Maximum Power Dissipation	T_C=25℃	P_D	150	W

Electrical Characteristics (T_c=25℃,unless otherwise noted)						
Parameter	**Symbol**	**Test Conditions**	**Min**	**Typ**	**Max**	**Units**
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V,I_D=250uA	900	—	—	V
Breakdown Temperature Coefficient	ΔBV_{DSS} /ΔT_J	Reference to 25℃ , I_D=250uA	—	0.95	—	V/℃
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=900V,V_{GS}=0V	—	—	25	uA
Gate-Body Leakage Current,Forward	I_{GSSF}	V_{GS}=20V,V_{DS}=0V	—	—	10	uA
Gate-Body Leakage Current,Reverse	I_{GSSR}	V_{GS}=-20V,V_{DS}=0V	—	—	-10	uA
On Characteristics						
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	2	—	4	V
Drain-Source On-State Resistance	$R_{DS(on)}$	V_{GS}=10V,I_D=4.5A	—	1.1	1.4	Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	V_{DS}=25V,V_{GS}=0V, f=1.0MHZ	—	3850	—	pF
Output Capacitance	C_{oss}		—	185	—	pF
Reverse Transfer Capacitance	C_{rss}		—	13	—	pF
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	V_{DD}=450V,I_D=4A, R_G=4.7Ω (Note3,4)	—	22	—	ns
Turn-On Rise Time	t_r		—	9	—	ns
Turn-Off Delay Time	$t_{d(off)}$		—	62	—	ns
Turn-Off Fall Time	t_f		—	23	—	ns
Total Gate Charge	Qg	V_{DS}=450V,I_D=9A, V_{GS}=10V, (Note3,4)	—	65	—	nC
Gate-Source Charge	Qgs		—	22	—	nC
Gate-Drain Charge	Qgd		—	18	—	nC
Drain-Source Body Diode Charcteristics and Maximum Ratings						
Continuous Diode Forward Current	I_S		—	—	9	A
Pulsed Diode Forward Current	I_{SM}		—	—	36	A
Diode Forward Voltage	V_{SD}	I_S=9A,V_{GS}=0V	—	—	1.5	V
Reverse Recovery Time	t_{rr}	V_{GS}=0V,I_S=9A, dI_F/dt=100A/us, (Note4)	—	1.2	—	us
Reverse Recovery Charge	Q_{rr}		—	9.4	—	uC

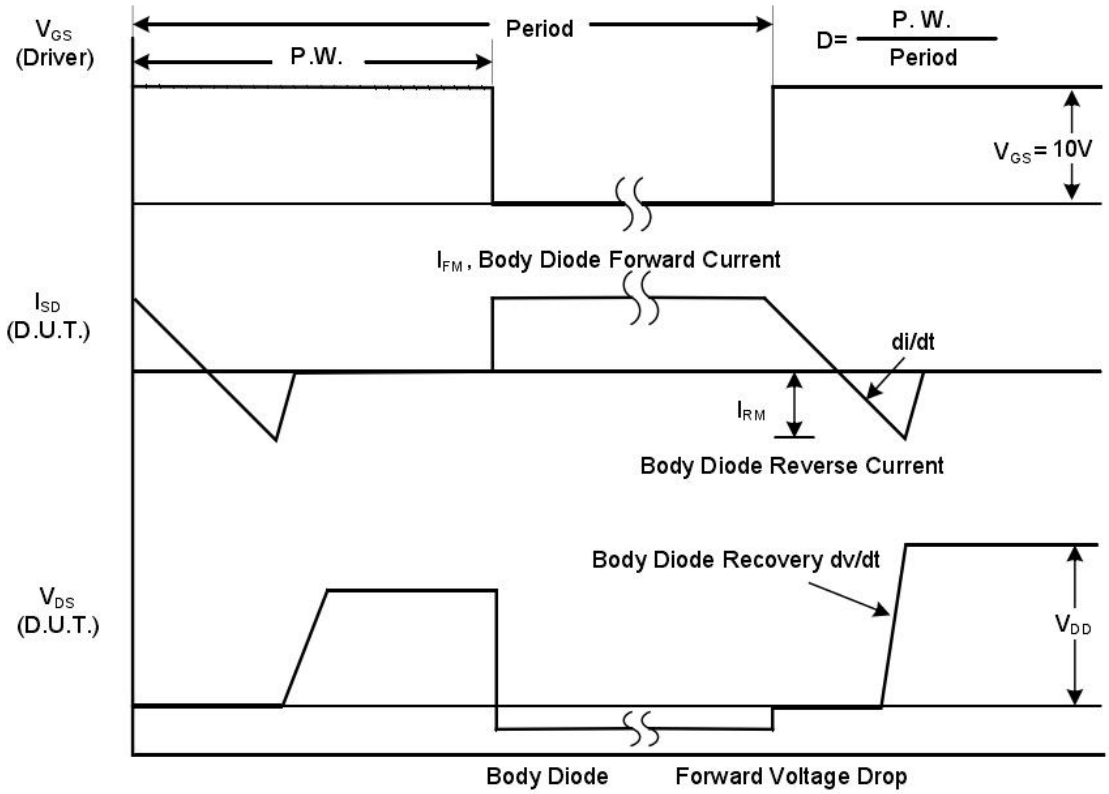
Notes

1. Repetitive Rating:pulse width limited by maximum junction temperature.
2. V_{DD}=50V,L=10mH,R_g=25Ω, starling T_J=25℃.
3. I_{SD}=9A,dI/dt≤100A/us,V_{DD}≤BV_{DSS},starting T_J=25℃,Pulse width≤300us;duty cycle≤2%.
4. Repetitive rating; pulse width limited by maximum junction temperature.

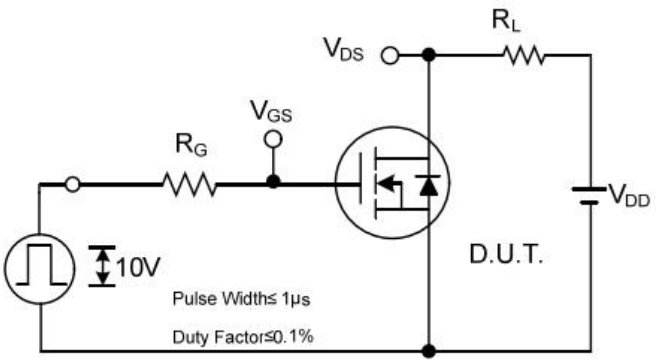
TEST CIRCUIT AND WAVEFORM



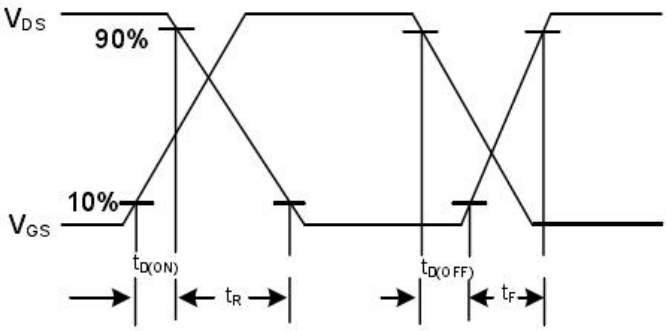
Peak Diode Recovery dv/dt Test Circuit



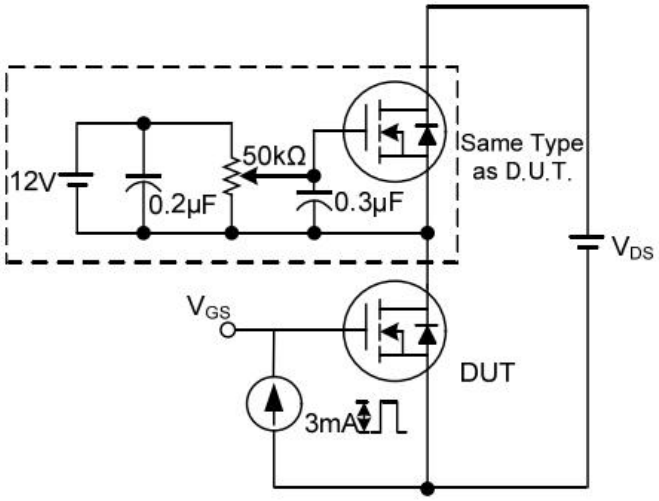
Peak Diode Recovery dv/dt Waveforms



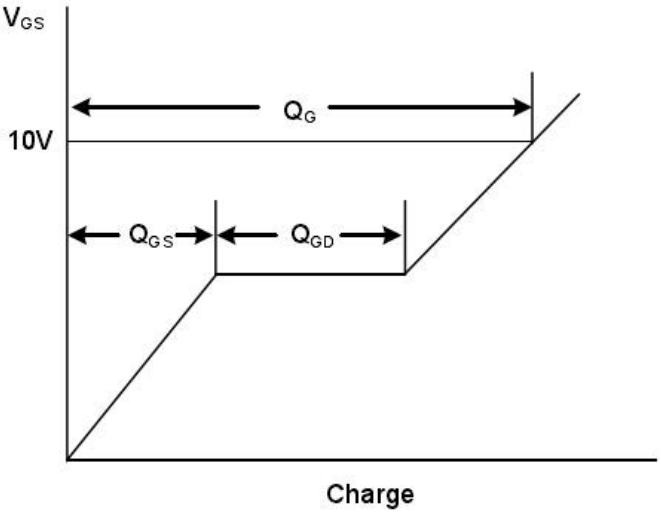
Switching Test Circuit



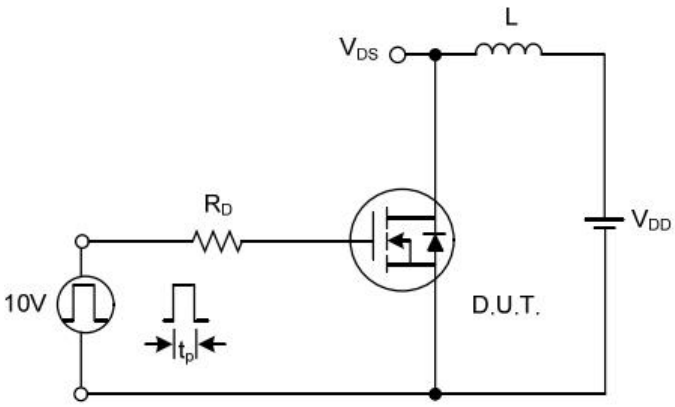
Switching Waveforms



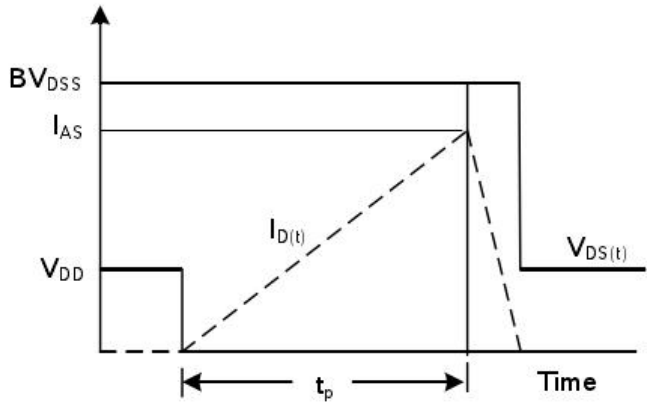
Gate Charge Test Circuit



Gate Charge Waveform

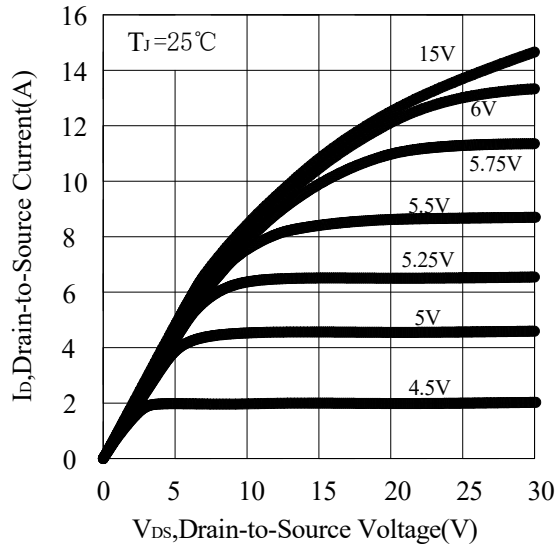


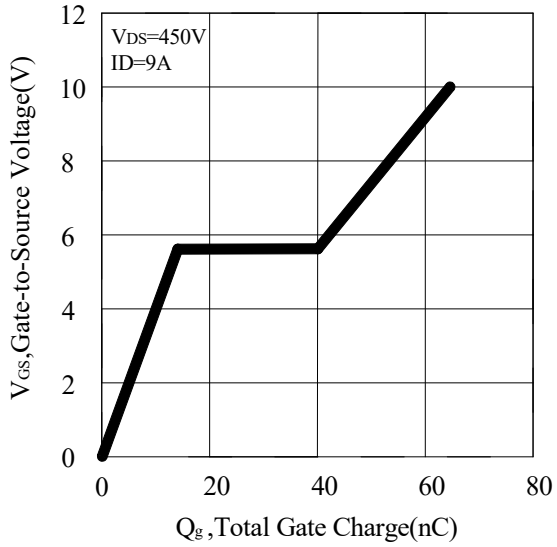
Unclamped Inductive Switching Test Circuit

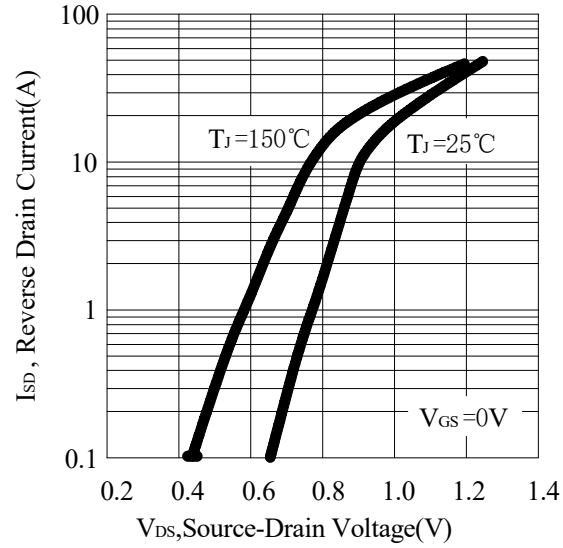


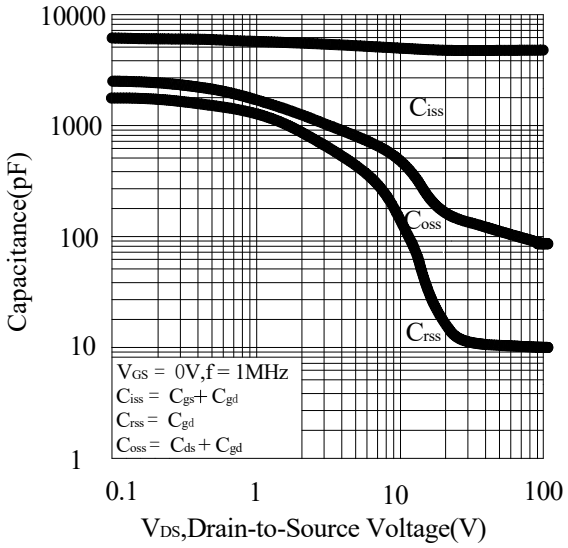
Unclamped Inductive Switching Waveforms

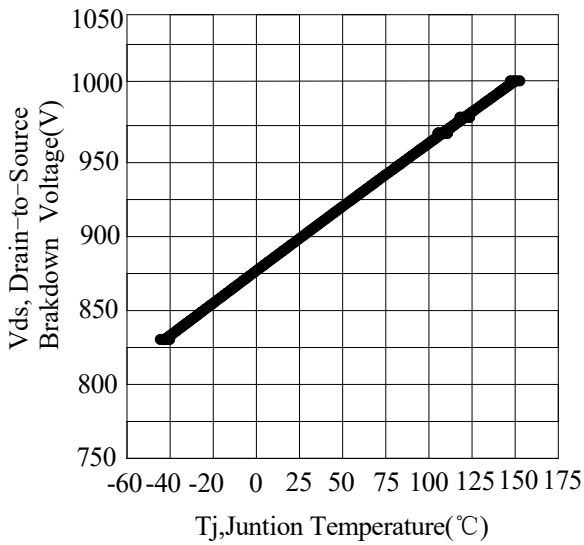
RATINGAND CHARACTERISTIC CURVES

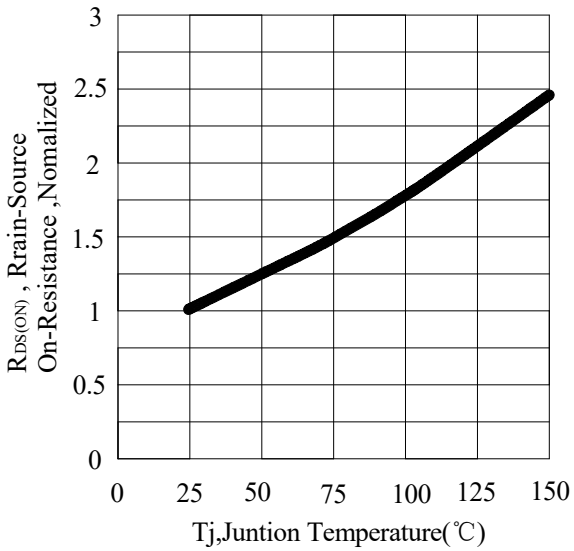


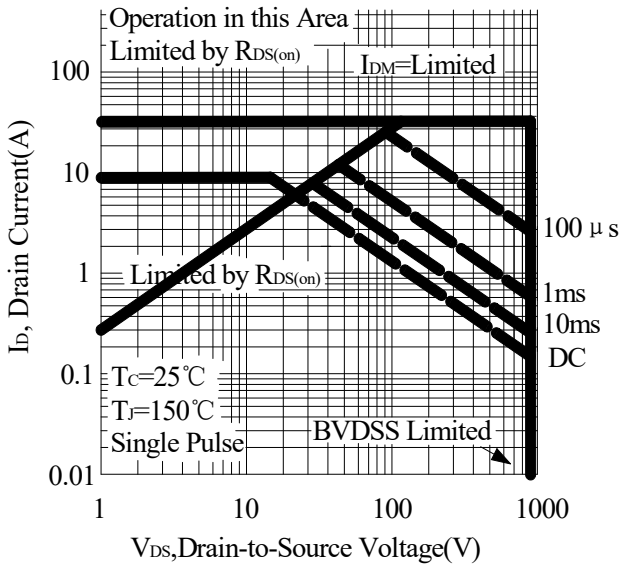


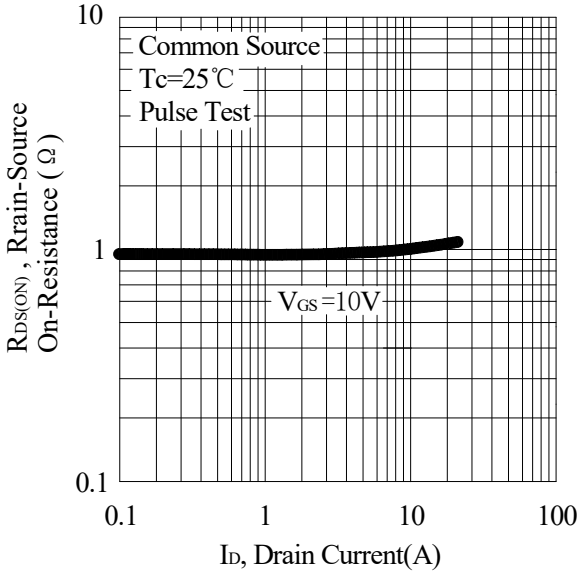


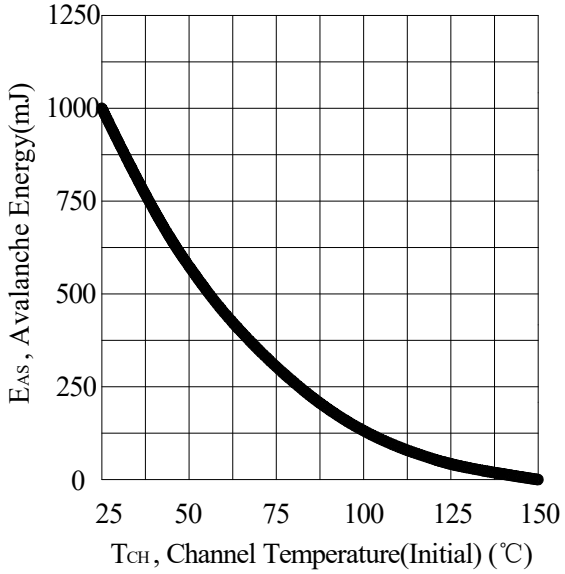


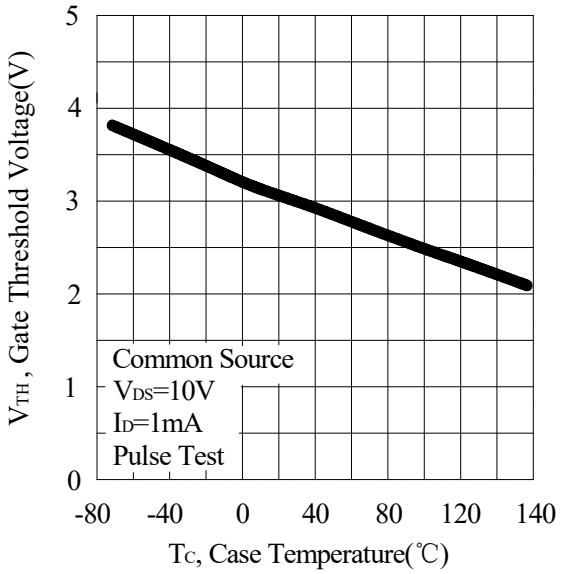


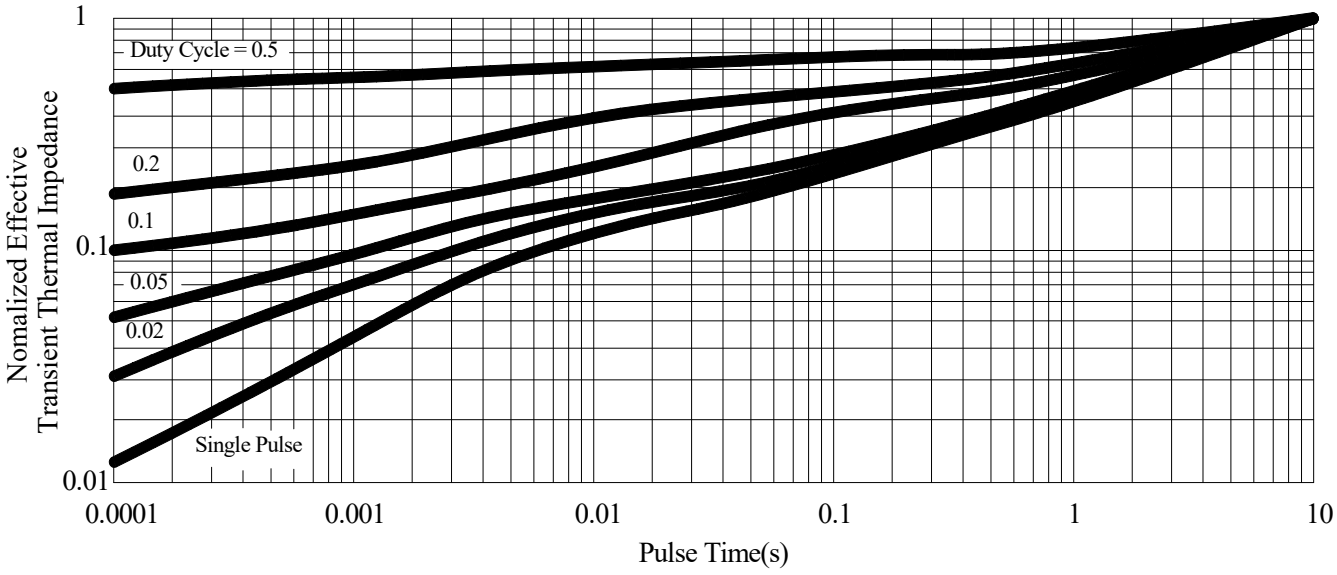



Operation in this Area
Limited by RDS(on)
IDM=Limited
100 μ s
1ms
10ms
DC
Limited by RDS(on)
TC=25℃
TJ=150℃
Single Pulse
BVDSS Limited
ID, Drain Current(A)
VDS,Drain-to-Source Voltage(V)
100
10
1
0.1
0.01
1
10
100
1000


Common Source
Tc=25℃
Pulse Test
VGS =10V
RDS(ON) , Rrain-Source On-Resistance (Ω)
ID, Drain Current(A)
10
1
0.1
0.1
1
10
100


EAS , Avalanche Energy(mJ)
TCH , Channel Temperature(Initial) (℃)
1250
1000
750
500
250
0
25
50
75
100
125
150


VTH , Gate Threshold Voltage(V)
Common Source
VDS=10V
ID=1mA
Pulse Test
TC, Case Temperature(℃)
5
4
3
2
1
0
-80
-40
0
40
80
120
140


Duty Cycle = 0.5
0.2
0.1
0.05
0.02
Single Pulse
Nomalized Effective Transient Thermal Impedance
Pulse Time(s)
1
0.1
0.01
0.0001
0.001
0.01
0.1
1
10

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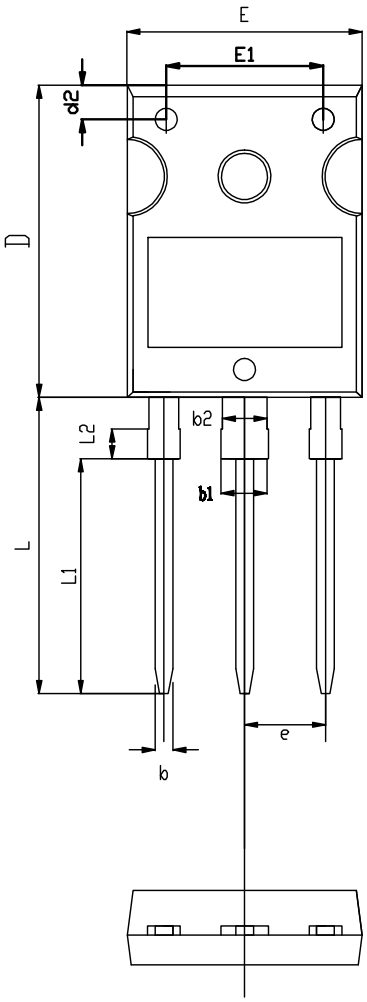
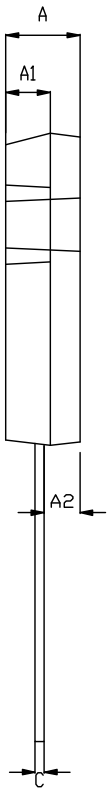
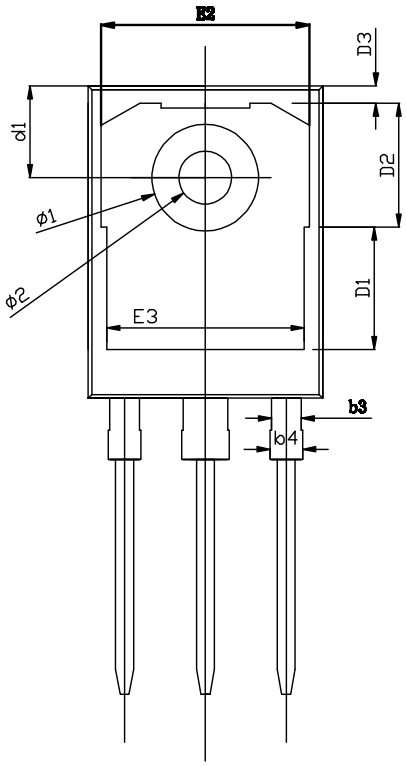
CHONGQING PINGWEI ENTERPRISE CO.,LTD

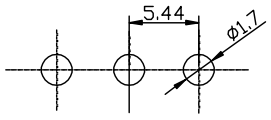
TO-247-3L PACKAGE OUTLINE







RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.80	3.00	3.20
A2	2.26	2.41	2.56
b	1.10	1.20	1.30
b1	2.90	-	3.20
b2	2.90	3.00	3.10
b3	1.90	2.00	2.10
b4	2.00	-	2.20
c	0.50	0.60	0.70
D	20.80	21.00	21.20
D1		8.23	
D2		8.32	
D3		1.17	
d1	6.00	6.15	6.30
d2	2.20	2.30	2.40
E	15.60	15.80	16.00
E1		10.50	
E2		14.02	
E3		13.50	
e	5.34	5.44	5.54
L	19.72	19.92	20.12
L1		15.79	
L2		1.98	
⌀1	7.10	7.19	7.30
⌀2	3.50	3.60	3.70